

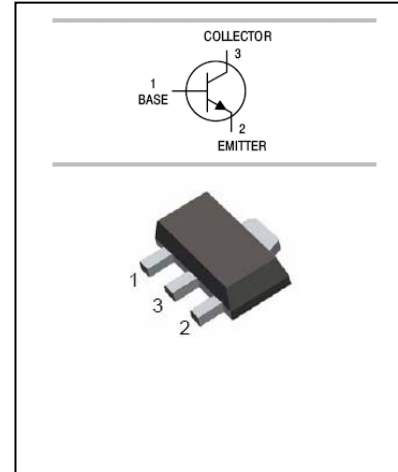
**NPN SILICON EPITAXIAL TRANSISTOR
POWER MINI MOLD**

2SC3357

FEATURES



- Low Noise and High Gain Lead-free
 $NF = 1.1 \text{ dB TYP.}, Ga = 8.0 \text{ dB TYP. @} V_{CE} = 10 \text{ V},$
 $I_C = 7 \text{ mA}, f = 1.0 \text{ GHz}$
 $NF = 1.8 \text{ dB TYP.}, Ga = 9.0 \text{ dB TYP. @} V_{CE} = 10 \text{ V},$
- Large PT in Small Package
 $PT : 2 \text{ W with } 16 \text{ cm}^2 \times 0.7 \text{ mm Ceramic Substrate.}$



APPLICATIONS

- The 2SC3357 is an NPN silicon epitaxial transistor designed For low noise amplifier at VHF, UHF and CATV band.
- It has large dynamic range and good current characteristic.

ORDERING INFORMATION

Type No.	Marking	Package Code
2SC3357	RH/RF/RE	SOT-89

MAXIMUM RATING @ Ta=25°C unless otherwise specified

Symbol	Parameter	Value	Units
V_{CBO}	Collector-Base Voltage	20	V
V_{CEO}	Collector-Emitter Voltage	12	V
V_{EBO}	Emitter-Base Voltage	3.0	V
I_C	Collector Current -Continuous	100	mA
P_T 备注 1	Total Power Dissipation	1.2	W
$R_{th(j-a)}$ 备注 1	Thermal Resistance	62.5	°C/W
T_j	Junction Temperature	150	°C
T_{stg}	Storage Temperature	-65 to +150	°C

备注 1: mounted on $16 \text{ cm}^2 \times 0.7 \text{ mm}$ Ceramic Substrate



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ELECTRICAL CHARACTERISTICS @ Ta=25°C unless otherwise specified

Parameter	Symbol	Test conditions	MIN	TYP	MAX	UNIT
Collector-to-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C=10\mu A$	20			V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C=1mA$	12			V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E=10\mu A$	3.0			V
Collector cut-off current	I_{CBO}	$V_{CB}=10V, I_E=0$			1	μA
Emitter cut-off current	I_{EBO}	$V_{EB}=1.0V, I_C=0$			1	μA
DC current gain	h_{FE} 备注 2	$V_{CE}=10V, I_C=20mA$	50	120	300	
Transition frequency	f_T	$V_{CE}=10V, I_C=20mA$		6.5		GHz
Feed-Back Capacitance	C_{re} 备注 3	$V_{CB} = 10 V, I_C = 0 mA,$ $f = 1.0 MHz$		0.65	1.0	pF
Insertion power gain	$ S_{21e} ^2$	$V_{CE}=10V, I_C=20mA,$ $f=1GHz$		9		dB
Noise Figure	NF	$V_{CE}=10V, I_C=7mA,$ $f=1GHz$		1.1		dB
Noise Figure	NF	$V_{CE}=10V, I_C=40mA,$ $f=1GHz$		1.8	3.0	dB

备注 2: Pulse Measurement $PW \leq 350 \mu s$, Duty Cycle $\leq 2 \%$

备注 3: The emitter terminal and the case shall be connected to the guard terminal of the three-terminal capacitance bridge.

CLASSIFICATION OF h_{FE}

Rank	RH	RF	RE
Range	50-100	80-160	125-250
MARKING	RH	RF	RE



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TYPICAL CHARACTERISTICS @ Ta=25°C unless otherwise specified

Fig.1 TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE

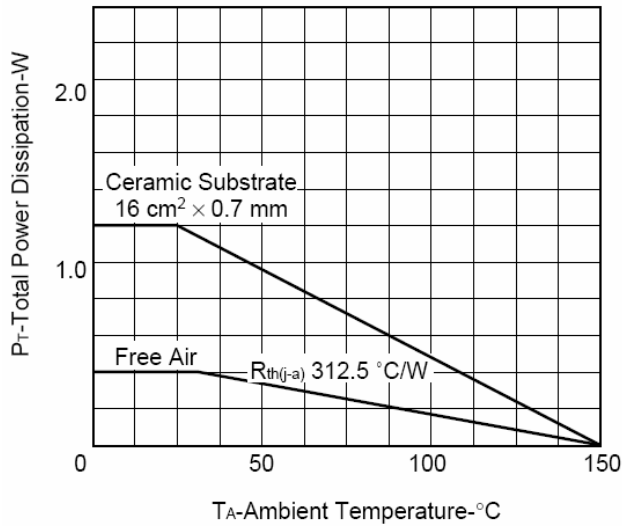


Fig.2 FEED-BACK CAPACITANCE vs. COLLECTOR TO BASE VOLTAGE

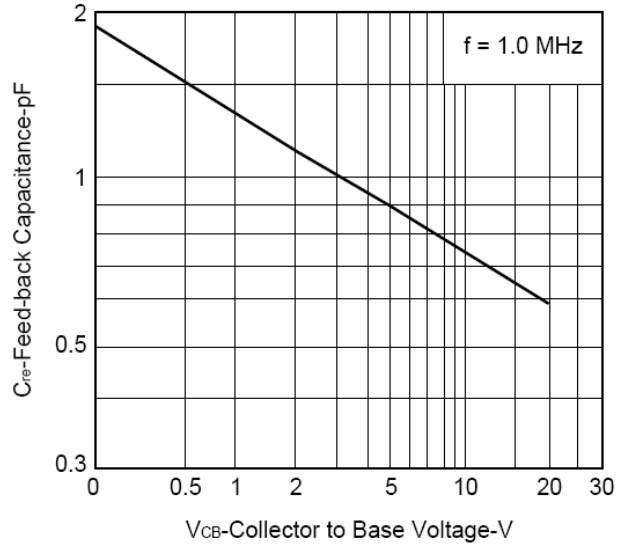


Fig.3 DC CURRENT GAIN vs. COLLECTOR CURRENT

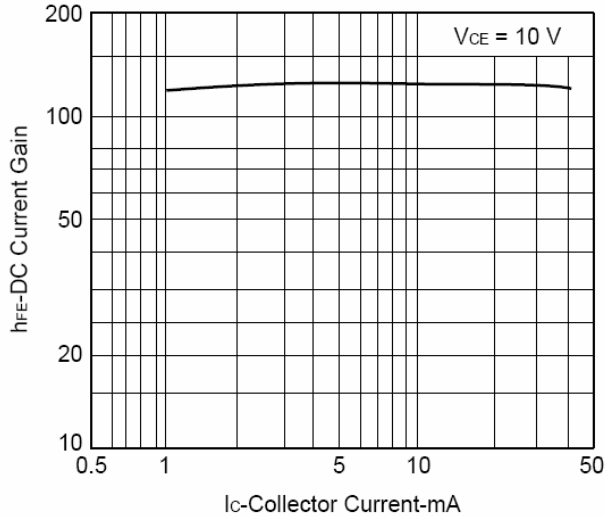
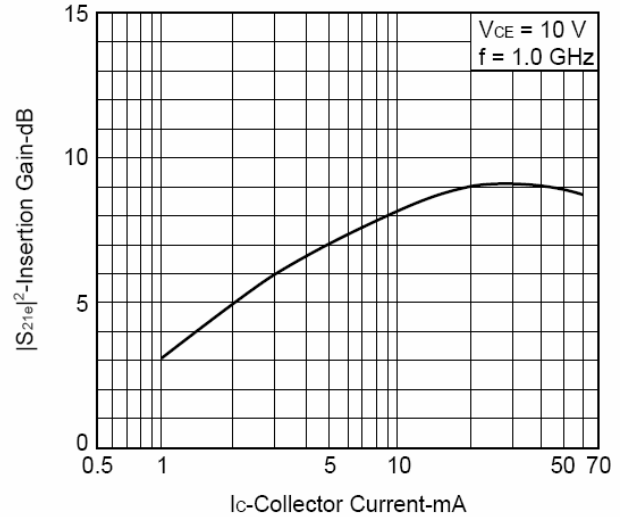


Fig.4 INSERTION GAIN vs. COLLECTOR CURRENT





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Fig.5 GAIN BANDWIDTH PRODUCT vs. COLLECTOR CURRENT

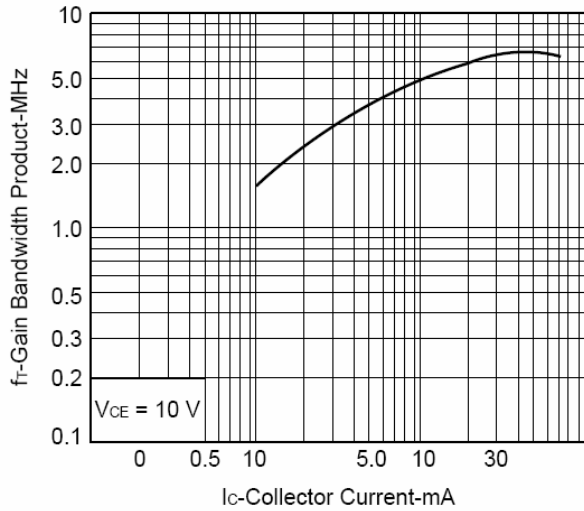


Fig.6 INSERTION GAIN, MAXIMUM GAIN vs. FREQUENCY

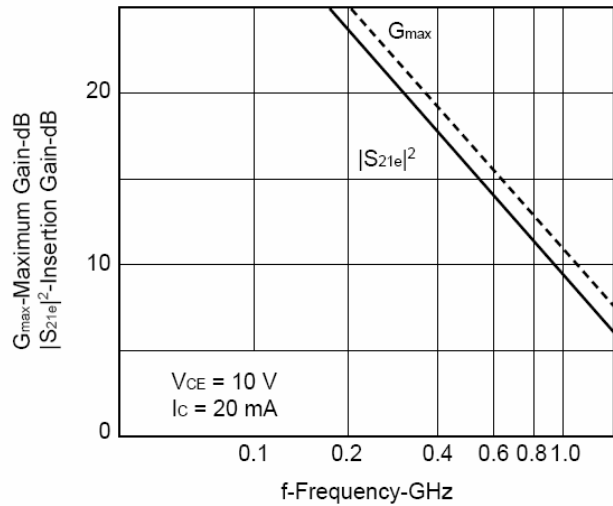


Fig.8 INTERMODULATION DISTORTION vs. COLLECTOR CURRENT

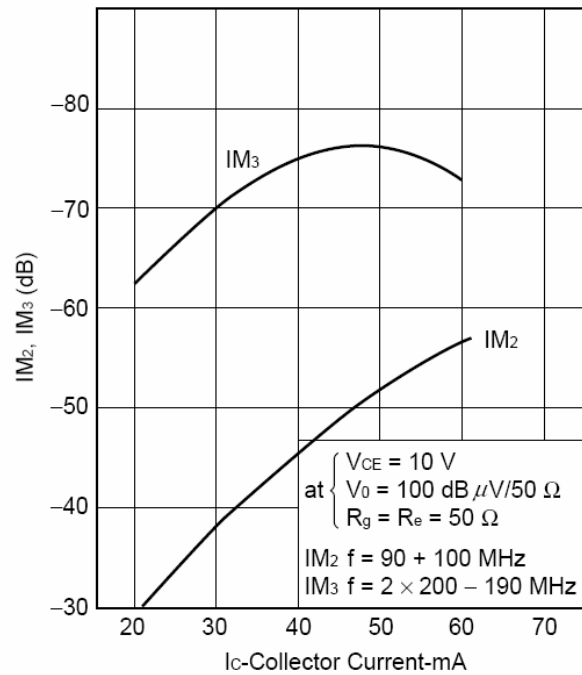
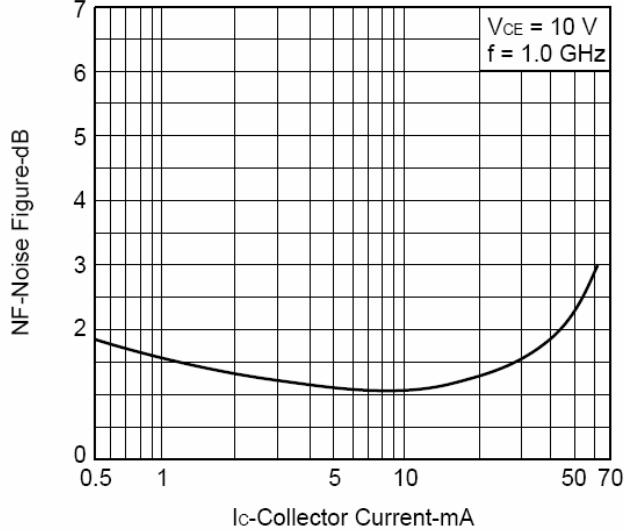


Fig.7 NOISE FIGURE vs. COLLECTOR CURRENT





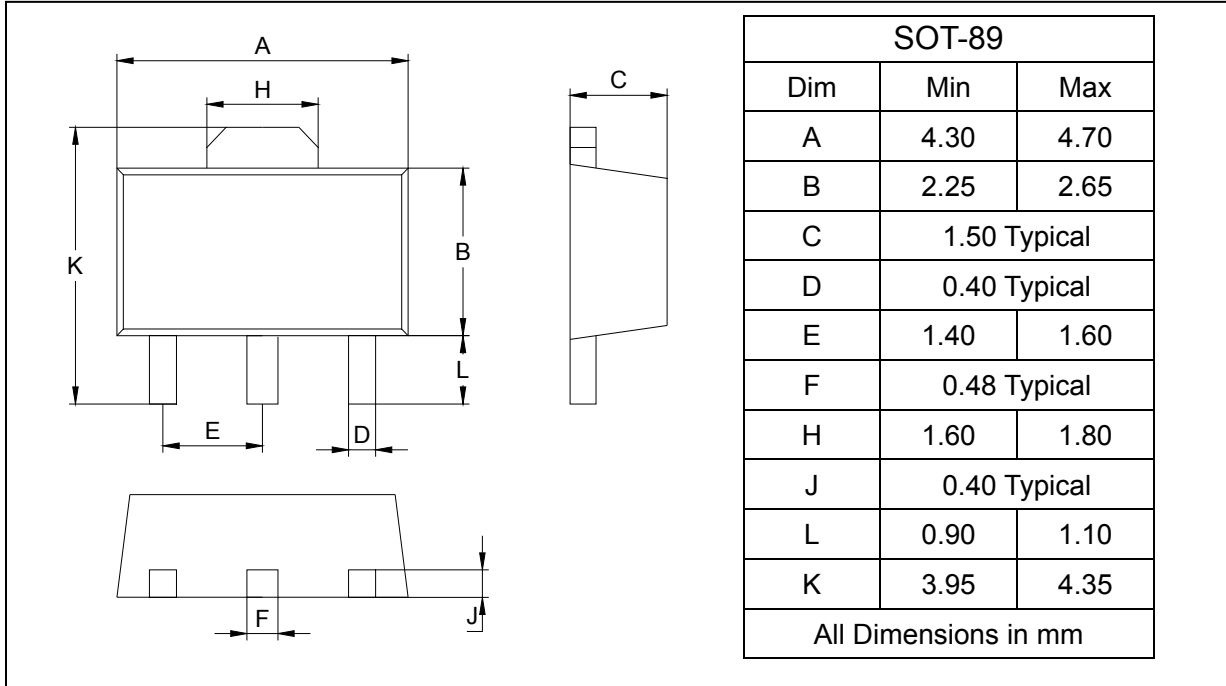
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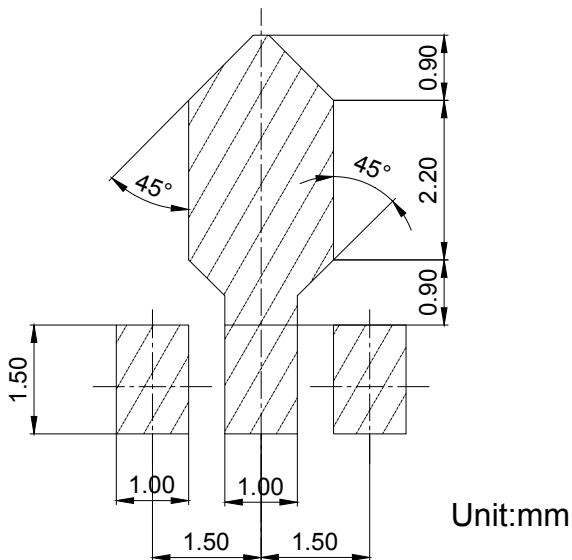
PACKAGE OUTLINE

Plastic surface mounted package

SOT-89



SOLDERING FOOTPRINT



PACKAGE INFORMATION

Device	Package	Shipping
2SC3357	SOT-89	1000/Tape&Reel